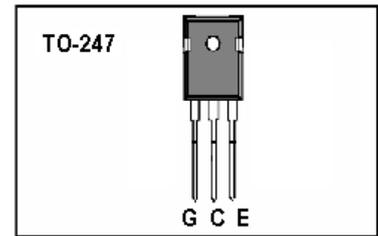
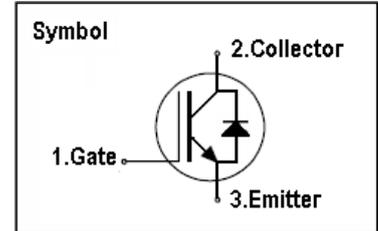


IGBT

Features

- 1200V,30A
- $V_{CE(sat)(typ.)}=2.2V@V_{GE}=15V,I_C=30A$
- High speed switching
- Higher system efficiency
- Soft current turn-off waveforms
- Square RBSOA using NPT technology



General Description

JIAEN NPT IGBTs offer lower losses and higher energy efficiency for application such as IH (induction heating), UPS, general inverter and other soft switching applications.

Absolute Maximum Ratings

Symbol	Parameter	Value	Units
V_{CES}	Collector-Emitter Voltage	1200	V
V_{GES}	Gate-Emitter Voltage	± 30	V
I_C	Continuous Collector Current ($T_C=25^\circ C$)	50	A
	Continuous Collector Current ($T_C=100^\circ C$)	30	A
I_{CM}	Pulsed Collector Current (Note 1)	100	A
I_F	Diode Continuous Forward Current ($T_C=100^\circ C$)	30	A
I_{FM}	Diode Maximum Forward Current (Note 1)	100	A
t_{sc}	Short Circuit Withstand Time	10	us
P_D	Maximum Power Dissipation ($T_C=25^\circ C$)	260	W
	Maximum Power Dissipation ($T_C=100^\circ C$)	105	W
T_J	Operating Junction Temperature Range	-55 to +150	$^\circ C$
T_{STG}	Storage Temperature Range	-55 to +150	$^\circ C$

Thermal Characteristics

Symbol	Parameter	Max.	Units
R_{thj-c}	Thermal Resistance, Junction to case for IGBT	0.48	$^\circ C/W$
R_{thj-c}	Thermal Resistance, Junction to case for Diode	0.95	$^\circ C/W$
R_{thj-a}	Thermal Resistance, Junction to Ambient	40	$^\circ C/W$

Electrical Characteristics ($T_C=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
BV_{CES}	Collector-Emitter Breakdown Voltage	$V_{GE}=0V, I_C=250\mu A$	1200	-	-	V
I_{CES}	Collector-Emitter Leakage Current	$V_{CE}=1200V, V_{GE}=0V$	-	-	250	μA
I_{GES}	Gate Leakage Current, Forward	$V_{GE}=30V, V_{CE}=0V$	-	-	100	nA
	Gate Leakage Current, Reverse	$V_{GE}=-30V, V_{CE}=0V$	-	-	-100	nA
$V_{GE(th)}$	Gate Threshold Voltage	$V_{GE}=V_{CE}, I_C=250\mu A$	4.0	5.0	6.0	V
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage	$V_{GE}=15V, I_C=30A$	-	2.2	2.6	V
Q_g	Total Gate Charge	$V_{CC}=960V$ $V_{GE}=15V$ $I_C=30A$	-	165		nC
Q_{ge}	Gate-Emitter Charge		-	33		nC
Q_{gc}	Gate-Collector Charge		-	70		nC
$t_{d(on)}$	Turn-on Delay Time	$V_{CC}=600V$ $V_{GE}=15V$ $I_C=30A$ $R_G=10\Omega$ Inductive Load $T_C=25^\circ\text{C}$	-	25	-	ns
t_r	Turn-on Rise Time		-	40	-	ns
$t_{d(off)}$	Turn-off Delay Time		-	300	-	ns
t_f	Turn-off Fall Time		-	170	-	ns
E_{on}	Turn-on Switching Loss		-	1.62	-	mJ
E_{off}	Turn-off Switching Loss		-	2.33	-	mJ
E_{ts}	Total Switching Loss		-	3.95	-	mJ
C_{ies}	Input Capacitance	$V_{CE}=25V$	-	1600	-	pF
C_{oes}	Output Capacitance	$V_{GE}=0V$	-	270	-	pF
C_{res}	Reverse Transfer Capacitance	$f=1\text{MHz}$	-	170	-	pF

Electrical Characteristics of Diode ($T_C=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
V_F	Diode Forward Voltage	$I_F=30A$	-	2.15	2.7	V
t_{rr}	Diode Reverse Recovery Time	$V_{CE}=600V$	-	210		ns
I_{rr}	Diode peak Reverse Recovery Current	$I_F=30A$	-	20		A
Q_{rr}	Diode Reverse Recovery Charge	$dI_F/dt=500A/\mu s$	-	2100		nC

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature

Typical Performance Characteristics

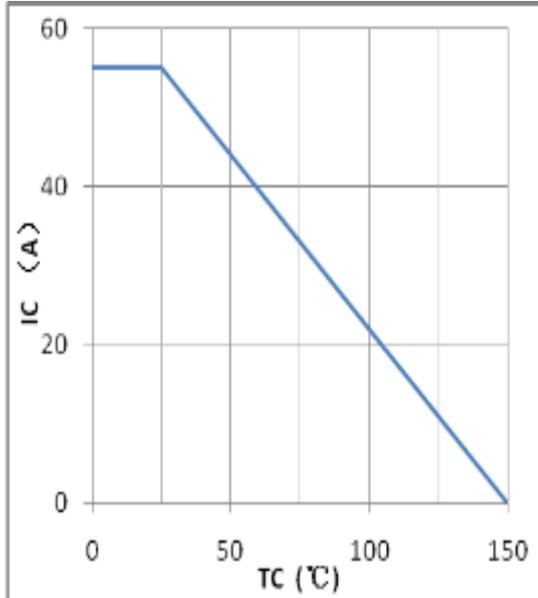


Figure1:maximum DC collector current VS. case temprature

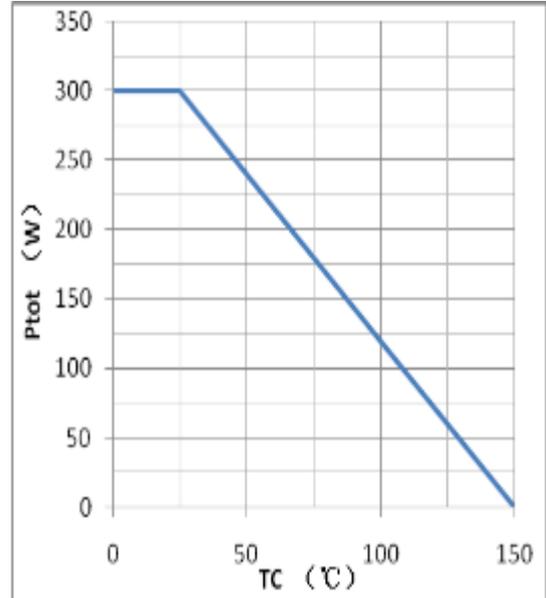


Figure2:power dissipation VS. case temprature

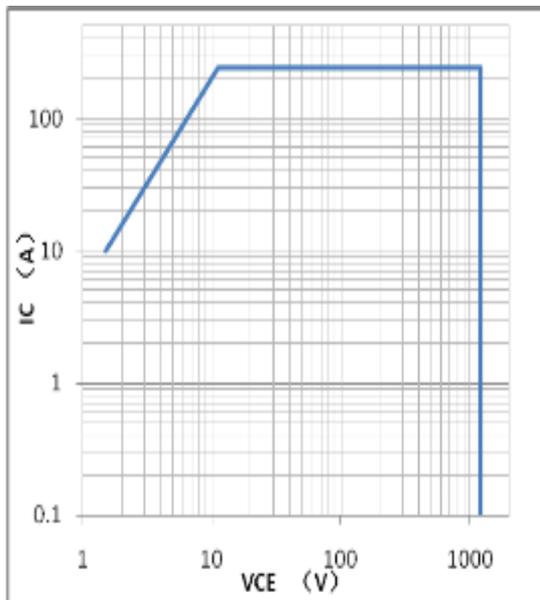


Figure3:reverse bias SOA,TJ=150°C,VGE=15V

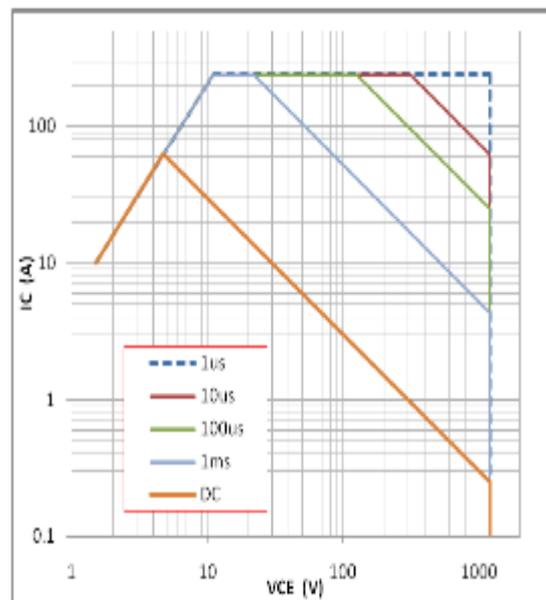


Figure4:forward SOA,TC=25°C,TJ≤150°C

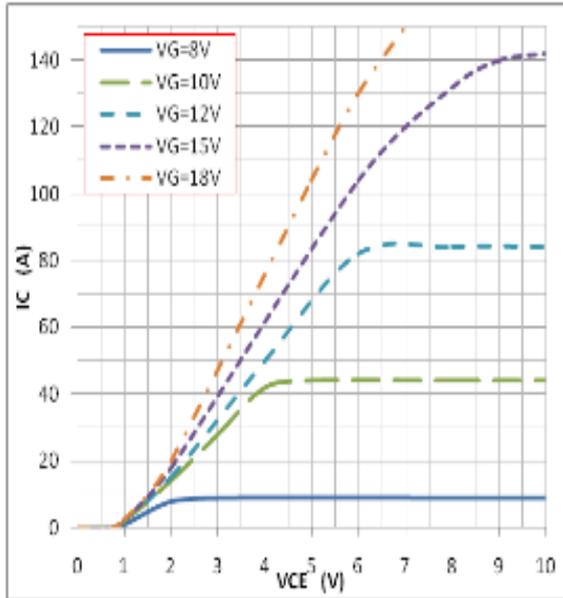


Figure5:typical IGBT output characteristics,
 $T_J=25^{\circ}\text{C}; t_p=300\mu\text{s}$

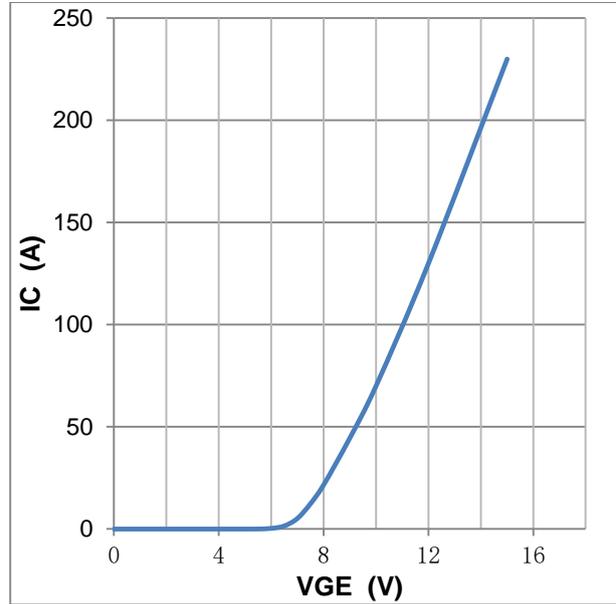


Figure6:typical trans characteristics, $V_{CE}=20\text{V}, t_p=20\mu\text{s}$

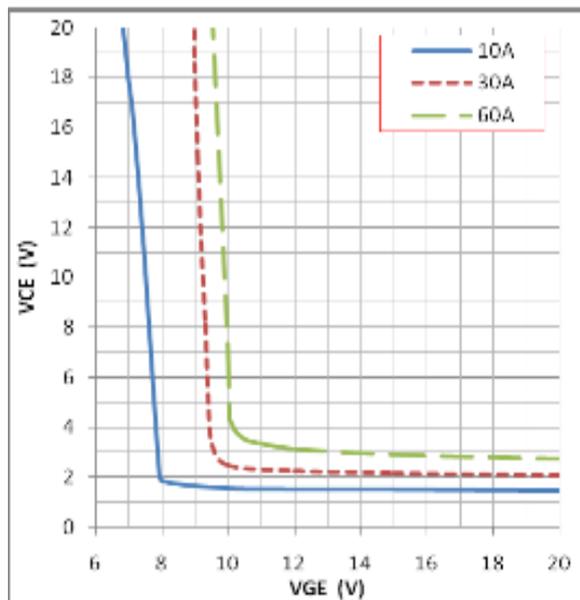


Figure7: typical V_{CE} VS. V_{GE} , $T_J=25^{\circ}\text{C}$

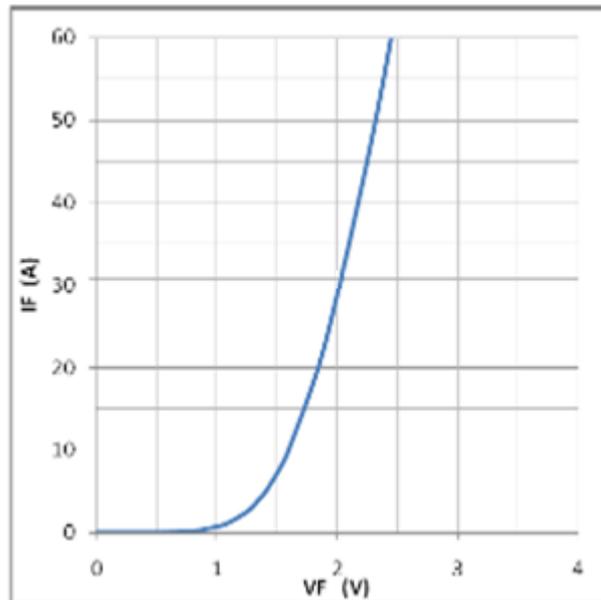


Figure8:typical diode forward characteristic, $t_p=300\mu\text{s}$

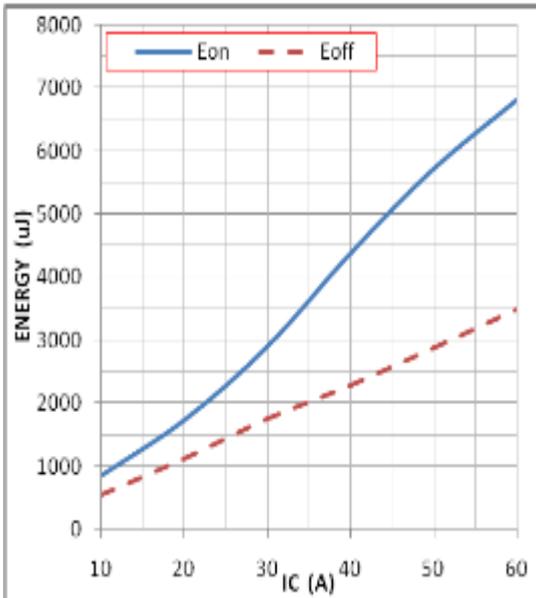


Figure9: typical energy loss VS. IC, TC=25°C,
L=500uH, VCE=600V,VGE=15V,Rg=28Ω

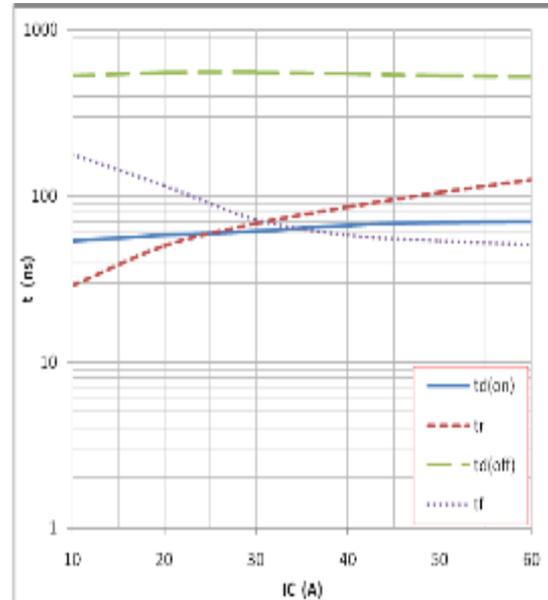


Figure10: typical switching time VS. IC, TC=25°C,
L=500uH, VCE=600V,VGE=15V,Rg=28Ω

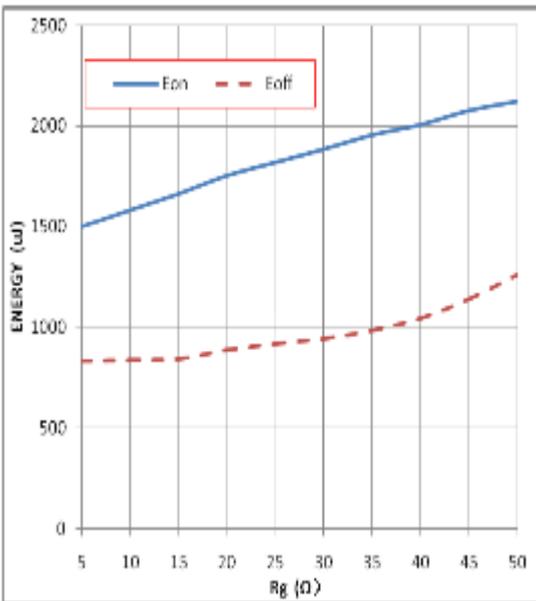


Figure11: typical energy loss VS. Rg,TC=25°C,
L=500uH, VCE=600V, VGE=15V,IC=20A

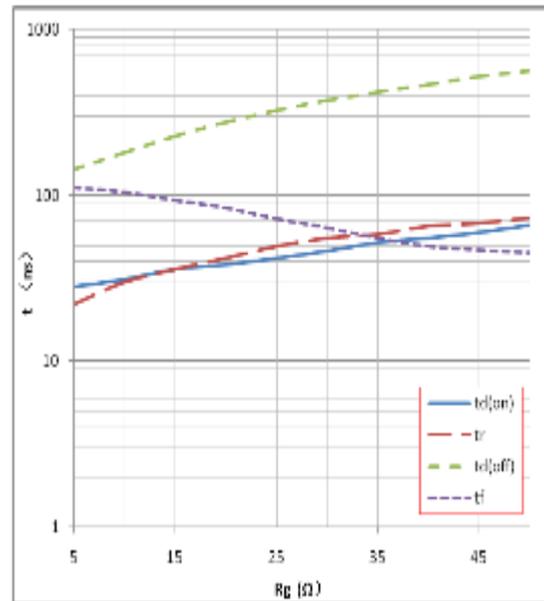


Figure12: typical switching time VS. Rg,TC=25°C,
L=500uH,VCE=600V,VGE=15V,IC=20A

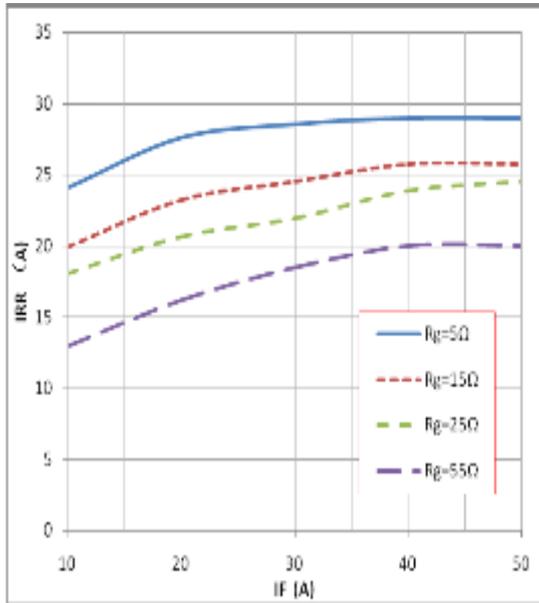


Figure13: typical diode IRR VS. IF, TC=25°C

VCC=600V, VGE=15V

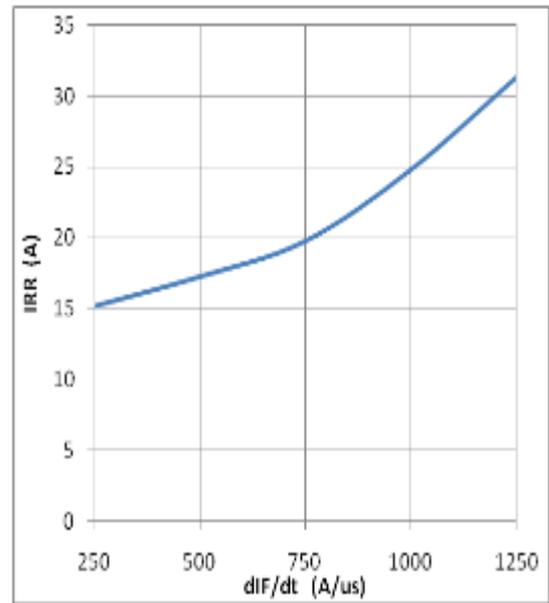


Figure14: typical diode IRR VS. dIF/dt

VCC=600V, VGE=15V

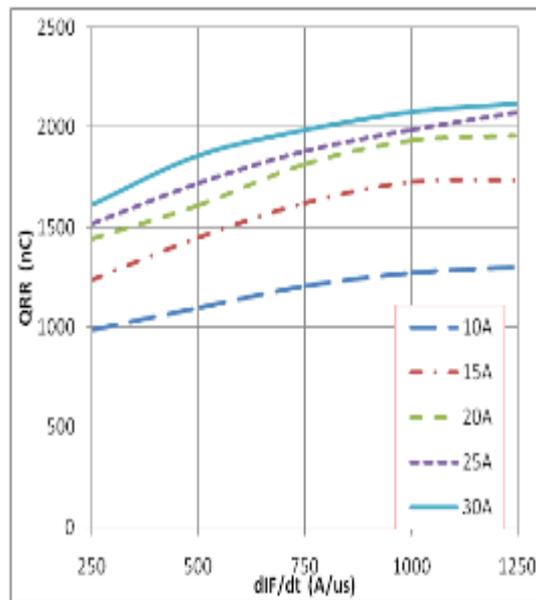


Figure15: typical diode QRR VS. dIF/dt

VCC=600V, VGE=15V

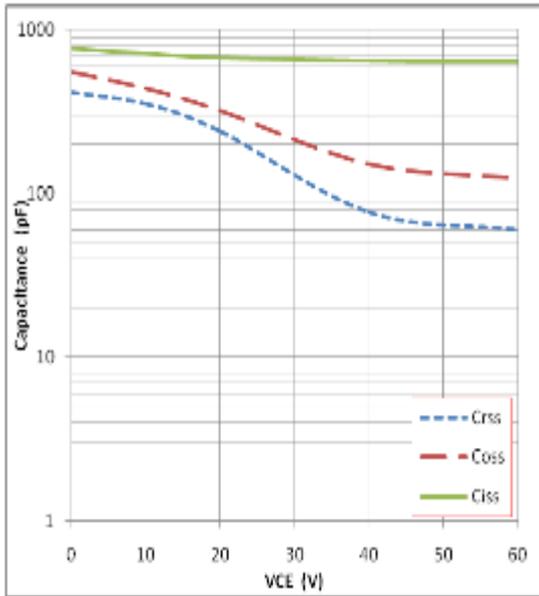


Figure17:typical capacitance VS. VCE,VGE=0V,f=100kHz

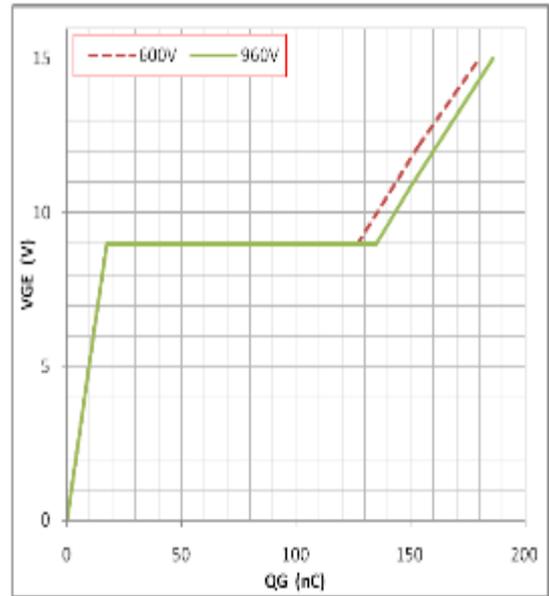


Figure18:typical gate charge VS. VGE,IC=20A

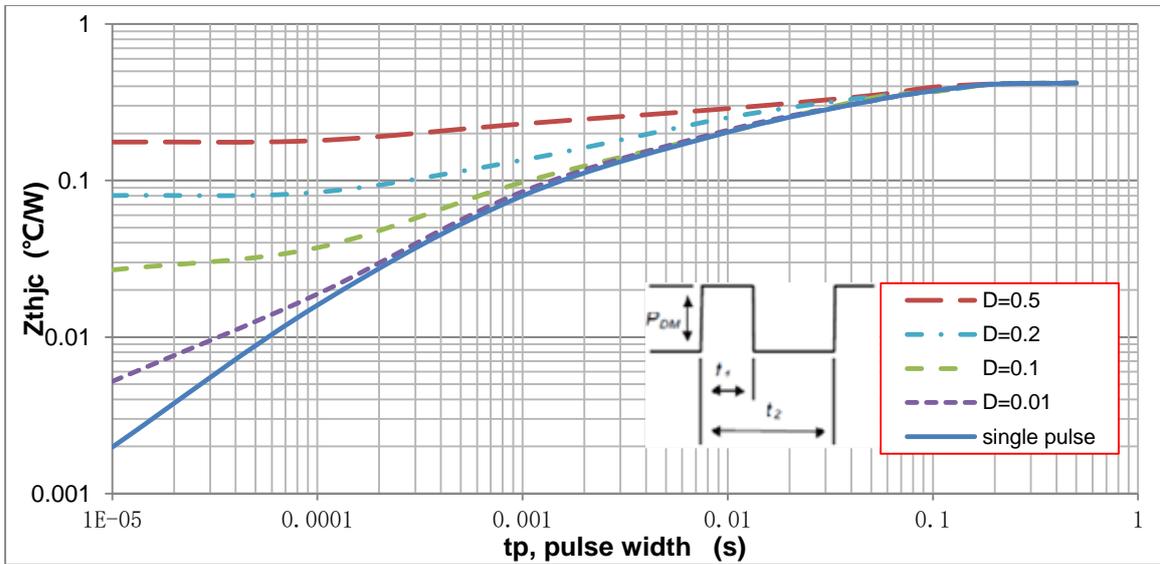


Figure19:normalised transient thermal impedance, junction-to-case

Note1.Duty factor $D=t_1/t_2$; Note2:peak $T_J=P_{DM} \times Z_{thjc} + T_C$

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